

T_{pkg} ESD Max Lead Temp for Soldering (Package Body for 10s)

Electrostatic Discharge Voltage at 100pF, 1500 Ω

ISL9V5036S3S / ISI9V5036P3 / ISL9V5036S3 Rev. C4, November 2009

260

4

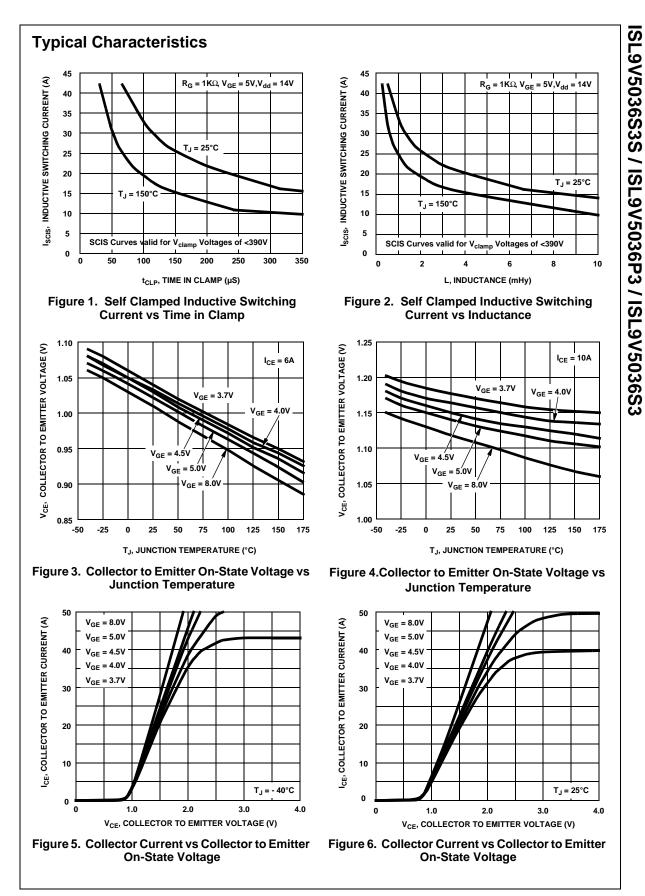
°C

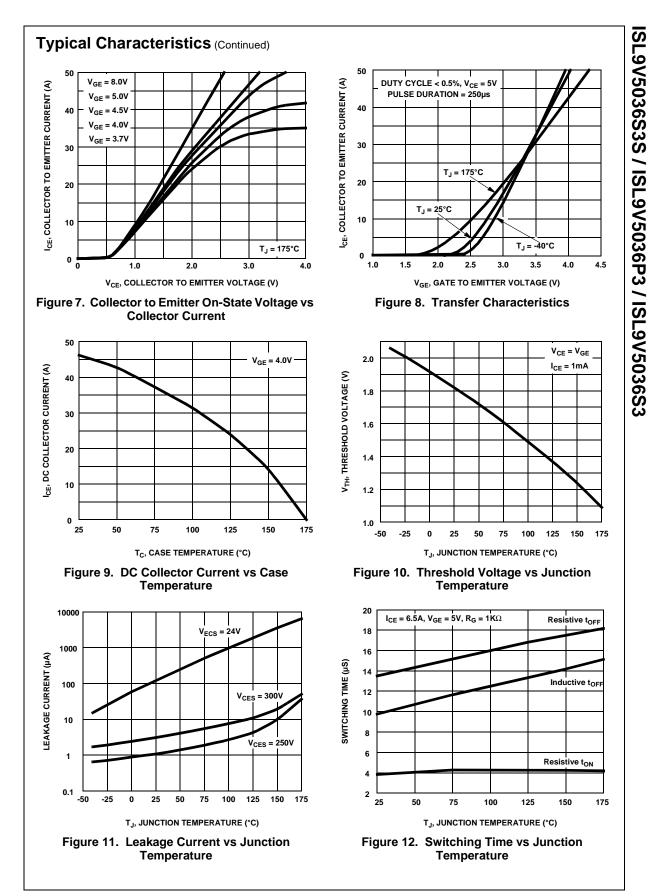
kV

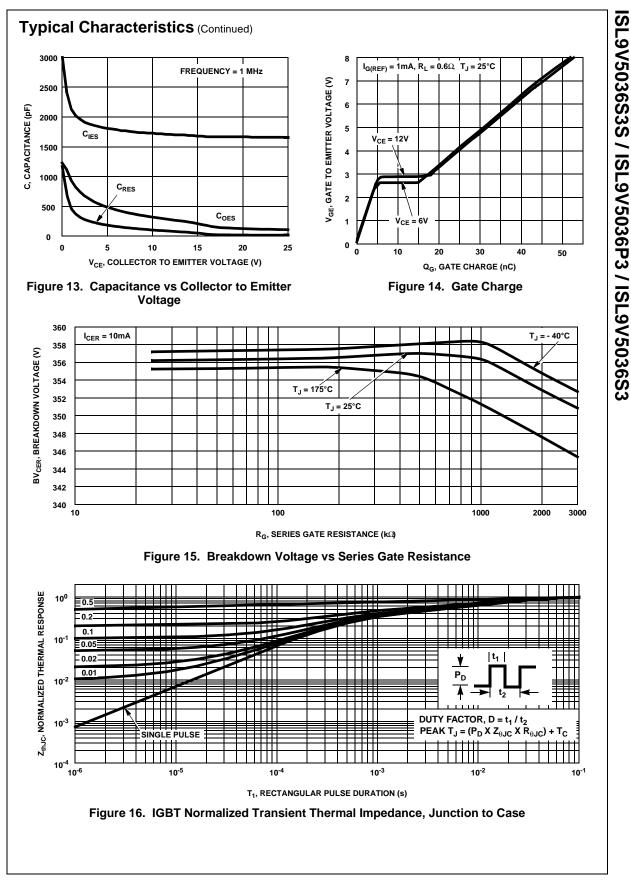
Device Marking		Device		Package	Reel Size	•	Tape Width		Quantity
V5036S V5036P V5036S		ISL9V5036S3ST ISL9V5036P3 ISL9V5036S3		TO-263AB	-220AA Tube -262AA Tube		24mm N/A N/A N/A		800
				TO-220AA					50 50 50
				TO-262AA					
V50	V5036S ISL9V5036S3S		TO-263AB						
ectrica	al Chara	acteristics T _A =	= 25°C un	less otherwise n	oted				
Symbol		Parameter		Test Conditions		Min	Тур	Мах	Units
f State	Characte	eristics							
BV _{CER}	Collector to Emitter Breakdown Voltage		$I_{C} = 2mA, V_{GE} = 0,$ $R_{G} = 1K\Omega, See Fig. 15$ $T_{J} = -40 \text{ to } 150^{\circ}\text{C}$		330	360	390	V	
BV _{CES}	Collector to Emitter Breakdown Voltage		$I_{C} = 10mA, V_{GE} = 0,$ $R_{G} = 0, See Fig. 15$ $T_{J} = -40 \text{ to } 150^{\circ}\text{C}$		360	390	420	V	
BV _{ECS}	Emitter to	Emitter to Collector Breakdown Voltage		$I_C = -75$ mA, $V_{GE} = 0$ V, $T_C = 25$ °C		30	-	-	V
BV_{GES}	Gate to Er	mitter Breakdown Vol	tage	$I_{GES} = \pm 2mA$		±12	±14	-	V
I _{CER}	Collector to Emitter Leakage Current			V _{CER} = 250V, R _G = 1KΩ See Fig. 11	$T_C = 25^{\circ}C$	-	-	25	μA
			T _C = 150°C		-	-	1	mA	
I _{ECS}	Emitter to	Emitter to Collector Leakage Current		$V_{EC} = 24V$, See	-	-	-	1	mA
_				Fig. 11	T _C = 150°C	-	-	40	mA
R ₁	Series Gate Resistance					75			
R ₂ n State	Gate to Er	mitter Resistance				- 10K	-	- 30K	ΩΩ
n State	Characte	mitter Resistance	Voltage	I _C = 10A, V _{GE} = 4.0V	T _C = 25°C, See Fig. 4		- - 1.17	- 30K 1.60	
n State	Characte Collector t	mitter Resistance		•			-	I	Ω
N State (V _{CE(SAT)} V _{CE(SAT)}	Characte Collector t	mitter Resistance ristics to Emitter Saturation ¹ to Emitter Saturation ¹		$V_{GE} = 4.0V$ $I_C = 15A,$	See Fig. 4	10K -	- 1.17	1.60	Ω V
N State (V _{CE(SAT)} V _{CE(SAT)}	Characte Collector t Collector t	mitter Resistance		$V_{GE} = 4.0V$ $I_C = 15A,$	See Fig. 4 T _C = 150°C	10K -	- 1.17	1.60	Ω V
n State V _{CE(SAT)} V _{CE(SAT)} /namic	Characte Collector t Collector t Characte Gate Char	mitter Resistance	Voltage	$V_{GE} = 4.0V$ $I_C = 15A,$ $V_{GE} = 4.5V$ $I_C = 10A, V_{CE} =$ $V_{GE} = 5V, See$ $I_C = 1.0mA,$	See Fig. 4 T _C = 150°C	10K -	- 1.17 1.50	1.60	Ω V V
n State $V_{CE(SAT)}$ $V_{CE(SAT)}$ $V_{CE(SAT)}$ $P_{CE(SAT)}$ $P_{CE(SAT)}$ $P_{CE(SAT)}$ $P_{CE(SAT)}$	Characte Collector t Collector t Characte Gate Char Gate to Er	mitter Resistance	Voltage	$\label{eq:VGE} \begin{split} & V_{GE} = 4.0V \\ & I_C = 15A, \\ & V_{GE} = 4.5V \\ \end{split} \\ & I_C = 10A, V_{CE} = \\ & V_{GE} = 5V, See \\ & I_C = 1.0mA, \\ & V_{CE} = V_{GE,} \\ & See \mbox{ Fig. 10} \end{split}$	$\frac{\text{See Fig. 4}}{\text{T}_{\text{C}} = 150^{\circ}\text{C}}$ = 12V, Fig. 14 $\frac{\text{T}_{\text{C}} = 25^{\circ}\text{C}}{\text{T}_{\text{C}} = 150^{\circ}\text{C}}$	10K - - 1.3 0.75	- 1.17 1.50 32 - -	1.60 1.80 - 2.2 1.8	Ω V V V V
N State V _{CE(SAT)} V _{CE(SAT)} /namic Q _{G(ON)}	Characte Collector t Collector t Characte Gate Char Gate to Er	mitter Resistance	Voltage	$V_{GE} = 4.0V$ $I_C = 15A,$ $V_{GE} = 4.5V$ $I_C = 10A, V_{CE} =$ $V_{GE} = 5V, See$ $I_C = 1.0mA,$ $V_{CE} = V_{GE},$	See Fig. 4 T _C = 150°C = 12V, Fig. 14 T _C = 25°C	10K - - - 1.3	- 1.17 1.50 32	1.60 1.80 - 2.2	Ω V V N nC V
n State V _{CE(SAT)} V _{CE(SAT)} V _{CE(SAT)} V _{GE(ON)} V _{GEP}	Characte Collector t Collector t Characte Gate Char Gate to Er	mitter Resistance	Voltage	$\label{eq:VGE} \begin{split} & V_{GE} = 4.0V \\ & I_C = 15A, \\ & V_{GE} = 4.5V \\ \end{split} \\ & I_C = 10A, V_{CE} = \\ & V_{GE} = 5V, See \\ & I_C = 1.0mA, \\ & V_{CE} = V_{GE,} \\ & See \mbox{ Fig. 10} \end{split}$	$\frac{\text{See Fig. 4}}{\text{T}_{\text{C}} = 150^{\circ}\text{C}}$ = 12V, Fig. 14 $\frac{\text{T}_{\text{C}} = 25^{\circ}\text{C}}{\text{T}_{\text{C}} = 150^{\circ}\text{C}}$	10K - - 1.3 0.75	- 1.17 1.50 32 - -	1.60 1.80 - 2.2 1.8	Ω V V V V
n State V _{CE(SAT)} V _{CE(SAT)} V _{CE(SAT)} (namic Q _{G(ON)} V _{GE(TH)} V _{GEP} witching	Characte Collector t Collector t Characte Gate Char Gate to Er Gate to Er	mitter Resistance	Voltage age	$V_{GE} = 4.0V$ $I_{C} = 15A,$ $V_{GE} = 4.5V$ $I_{C} = 10A, V_{CE} =$ $V_{GE} = 5V, See$ $I_{C} = 1.0mA,$ $V_{CE} = V_{GE},$ See Fig. 10 $I_{C} = 10A,$ $V_{CE} = 14V, R_{L} =$	See Fig. 4 $T_C = 150^{\circ}C$ Fig. 14 $T_C = 25^{\circ}C$ $T_C = 150^{\circ}C$ $V_{CE} = 12V$ = 1Ω,	10K - - 1.3 0.75	- 1.17 1.50 32 - -	1.60 1.80 - 2.2 1.8	Ω V V V V
n State V _{CE(SAT)} V _{CE(SAT)} V _{CE(SAT)} V _{GE(ON)} V _{GEP}	Characte Collector t Collector t Characte Gate Char Gate to Er Gate to Er Gate to Er Current Tu Current R	mitter Resistance	Voltage age esistive	$\label{eq:VGE} \begin{array}{l} V_{GE} = 4.0V \\ \hline I_{C} = 15A, \\ V_{GE} = 4.5V \\ \hline \end{array} \\ \begin{array}{l} I_{C} = 10A, \ V_{CE} = \\ V_{GE} = 5V, \ See \\ \hline I_{C} = 1.0mA, \\ V_{CE} = V_{GE}, \\ See \ Fig. \ 10 \\ \hline \\ I_{C} = 10A, \\ \hline \end{array} \\ \begin{array}{l} V_{CE} = 14V, \ R_{L} = \\ V_{GE} = 5V, \ R_{G} = \\ \hline \\ T_{J} = 25^{\circ}C, \ See \\ \end{array}$	See Fig. 4 $T_C = 150^{\circ}C$ Fig. 14 $T_C = 25^{\circ}C$ $T_C = 150^{\circ}C$ $V_{CE} = 12V$ = 1Ω, 1KΩ Fig. 12	10K - - 1.3 0.75 -	- 1.17 1.50 32 - - 3.0	1.60 1.80 - 2.2 1.8 -	Ω V V nC V V V
n State $V_{CE(SAT)}$ $V_{CE(SAT)}$ $V_{CE(SAT)}$ $V_{CE(SAT)}$ $V_{GE(SAT)}$ $V_{GE(ON)}$ $V_{GE(TH)}$ V_{GEP} witching $t_{d(ON)R}$	Characte Collector t Collector t Collector t Characte Gate Char Gate to En Gate to En Gate to En Gate to En Current Tu Current Tu Current Tu	mitter Resistance ristics to Emitter Saturation to Emitter Saturation ristics rge mitter Threshold Volta mitter Plateau Voltage teristics urn-On Delay Time-R ise Time-Resistive urn-Off Delay Time-In	Voltage age esistive	$\label{eq:VGE} \begin{split} & V_{GE} = 4.0V \\ & I_C = 15A, \\ & V_{GE} = 4.5V \\ \end{split} \\ & I_C = 10A, V_{CE} = \\ & V_{GE} = 5V, See \\ & I_C = 1.0mA, \\ & V_{CE} = V_{GE}, \\ & See Fig. 10 \\ & I_C = 10A, \\ \cr & V_{CE} = 10A, \\ \cr & V_{CE} = 5V, R_G = \\ & T_J = 25^\circ C, See \\ & V_{CE} = 300V, L = \\ \cr \end{split}$	See Fig. 4 $T_C = 150^{\circ}C$ Fig. 14 $T_C = 25^{\circ}C$ $T_C = 150^{\circ}C$ $V_{CE} = 12V$ = 1Ω, 1KΩ Fig. 12 = 2mH,	10K - - 1.3 0.75 -	- 1.17 1.50 32 - 3.0 0.7 2.1 10.8	1.60 1.80 - 2.2 1.8 - 4 7 15	Ω V V V N V V V V V V V
n State $V_{CE(SAT)}$ $V_{CE(SAT)}$ $V_{CE(SAT)}$ $V_{CE(SAT)}$ $V_{GE(SAT)}$ $V_{GE(TH)}$ V_{GEP} vitching $t_{d(ON)R}$ t_{rR}	Characte Collector t Collector t Collector t Characte Gate Char Gate to En Gate to En Gate to En Gate to En Current Tu Current Tu Current Tu	mitter Resistance	Voltage age esistive	$\label{eq:VGE} \begin{array}{l} V_{GE} = 4.0V \\ \hline I_{C} = 15A, \\ V_{GE} = 4.5V \\ \hline \end{array} \\ \begin{array}{l} I_{C} = 10A, \ V_{CE} = \\ V_{GE} = 5V, \ See \\ \hline I_{C} = 1.0mA, \\ V_{CE} = V_{GE}, \\ See \ Fig. \ 10 \\ \hline \\ I_{C} = 10A, \\ \hline \end{array} \\ \begin{array}{l} V_{CE} = 14V, \ R_{L} = \\ V_{GE} = 5V, \ R_{G} = \\ \hline \\ T_{J} = 25^{\circ}C, \ See \\ \end{array}$	See Fig. 4 $T_C = 150^{\circ}C$ Fig. 14 $T_C = 25^{\circ}C$ $T_C = 150^{\circ}C$ $V_{CE} = 12V$ = 1Ω, 1KΩ Fig. 12 = 2mH, 1KΩ	10K - - 1.3 0.75 - - -	- 1.17 1.50 32 - - 3.0 0.7 2.1	1.60 1.80 - 2.2 1.8 - 4 7	Ω V V N
n State $V_{CE(SAT)}$ $V_{CE(SAT)}$ $V_{CE(SAT)}$ $V_{CE(SAT)}$ $V_{GE(SAT)}$ $V_{GE(ON)}$ $V_{GE(TH)}$ V_{GEP} vitching $t_{d(ON)R}$ t_{rR} $t_{d(OFF)L}$	Characte Collector t Collector t Collector t Characte Gate Char Gate to Er Gate to Er Gate to Er Current Tu Current Tu Current Tu Current Tu	mitter Resistance ristics to Emitter Saturation T to Emitter Saturation T eristics rge mitter Threshold Volta mitter Plateau Voltage teristics urn-On Delay Time-R ise Time-Resistive urn-Off Delay Time-In	Voltage age esistive ductive	$\label{eq:VGE} \begin{split} & V_{GE} = 4.0V \\ & I_C = 15A, \\ & V_{GE} = 4.5V \\ \end{split} \\ & I_C = 10A, V_{CE} = \\ & V_{GE} = 5V, See \\ & I_C = 1.0mA, \\ & V_{CE} = V_{GE}, \\ & See Fig. 10 \\ & I_C = 10A, \\ \cr & V_{CE} = 10A, \\ \cr & V_{CE} = 5V, R_G = \\ & T_J = 25^\circ C, See \\ & V_{CE} = 300V, L = \\ & V_{GE} = 5V, R_G = \\ \cr & V_{CE} = 5V, R_G = \\ \hline & V_{CE} = 5V, R_G$	See Fig. 4 $T_C = 150^{\circ}C$ Fig. 14 $T_C = 25^{\circ}C$ $T_C = 150^{\circ}C$ $V_{CE} = 12V$ = 1Ω, 1KΩ Fig. 12 = 2mH, 1KΩ Fig. 12 = 2mH, 1KΩ Fig. 12 = 670 μH,	10K - - 1.3 0.75 - - -	- 1.17 1.50 32 - 3.0 0.7 2.1 10.8	1.60 1.80 - 2.2 1.8 - 4 7 15	Ω V V V N V V V V V V V V V V V V
n State $V_{CE(SAT)}$ $V_{CE(SAT)}$ $V_{CE(SAT)}$ $V_{CE(SAT)}$ $Q_{G(ON)}$ $V_{GE(TH)}$ V_{GEP} vitching $t_{d(ON)R}$ t_{rR} $t_{d(OFF)L}$ t_{fL} SCIS	Characte Collector t Collector t Collector t Characte Gate Char Gate to Er Gate to Er Gate to Er Current Tu Current Tu Current Tu Current Tu	mitter Resistance	Voltage age esistive ductive	$\begin{split} & V_{GE} = 4.0V \\ & I_C = 15A, \\ & V_{GE} = 4.5V \\ & I_C = 10A, V_{CE} = \\ & V_{GE} = 5V, See \\ & I_C = 1.0mA, \\ & V_{CE} = V_{GE}, \\ & See Fig. 10 \\ & I_C = 10A, \\ & V_{CE} = 5V, R_G = \\ & T_J = 25^\circ C, See \\ & V_{CE} = 300V, L = \\ & V_{GE} = 5V, R_G = \\ & T_J = 25^\circ C, See \\ & T_J = 25^\circ C, See \\ & T_J = 25^\circ C, See \\ & T_J = 25^\circ C, L = 0 \\ & R_G = 1K\Omega, V_{GE} \\ & V_{GE} V_{GE} $	See Fig. 4 $T_C = 150^{\circ}C$ Fig. 14 $T_C = 25^{\circ}C$ $T_C = 150^{\circ}C$ $V_{CE} = 12V$ = 1Ω, 1KΩ Fig. 12 = 2mH, 1KΩ Fig. 12 = 2mH, 1KΩ Fig. 12 = 670 μH,	10K - - 1.3 0.75 - - - - - - - -	- 1.17 1.50 32 - - 3.0 0.7 2.1 10.8 2.8	1.60 1.80 - 2.2 1.8 - 4 7 15 15	Ω V V V N V V V V V V V V V V V V

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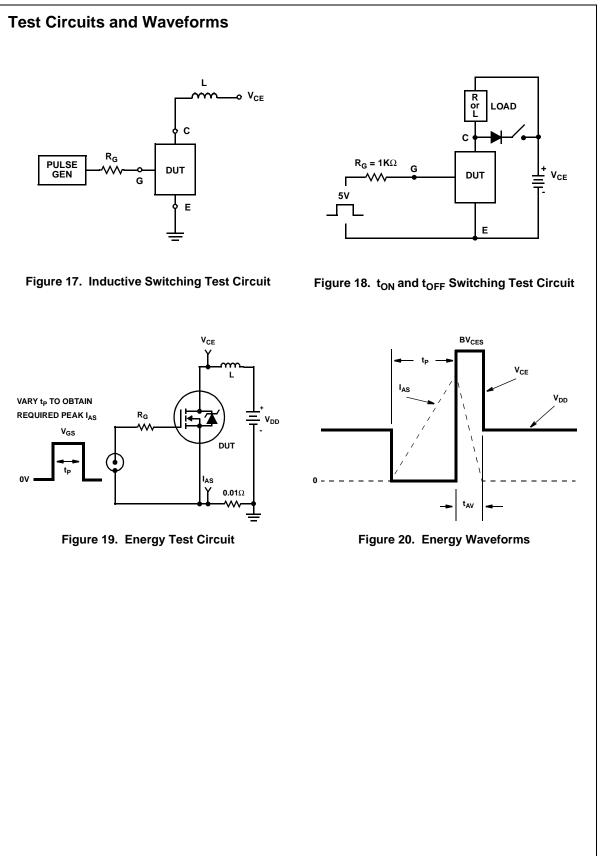
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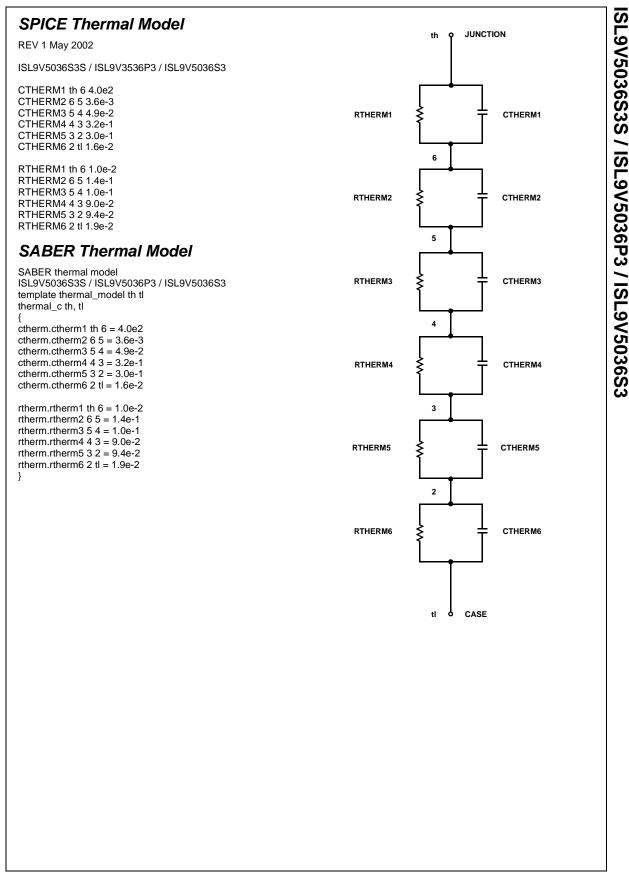




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